

March 2015

Dual N & P-Channel PowerTrench[®] MOSFET N-Channel: 80V, 13.9A, 80m Ω P-Channel: -80V, -9.4A, 190m Ω

Features

- Q1: N-Channel
- Max $r_{DS(on)}$ = 80m Ω at V_{GS} = 10V, I_D = 4.3A
- Max $r_{DS(on)}$ = 88m Ω at V_{GS} = 6V, I_D = 4.1A

Q2: P-Channel

- Max $r_{DS(on)}$ = 190m Ω at V_{GS} = -10V, I_D = -2.8A
- Max $r_{DS(on)}$ = 224m Ω at V_{GS} = -4.5V, I_D = -2.6A
- 100% UIL Tested
- RoHS Compliant

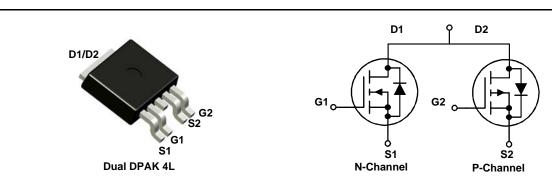


General Description

These dual N and P- Channel enha ncement mode Pow er MOSFETs ar e produ ced u sing Fa irchild Semiconductor 's advanced PowerT rench[®] process that has been especially tailored to minimize on -state r esistance and yet maint ain superior switching performance.

Applications

- Inverter
- H-Bridge



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		Q1	Q2	Units
V _{DS}	Drain to Source Voltage			-80	V
V _{GS}	Gate to Source Voltage		±20	±20	V
Ι _D	Drain Current - Continuous	T _C = 25°C	13.9	-9.4	
	- Continuous	T _A = 25°C	4.3	-2.8	Α
	- Pulsed		20	-10	_
P _D	Power Dissipation for Single Operation	T _C = 25°C (Note 1)	35	32	
		T _A = 25°C (Note 1a) 3.1		.1	W
		$T_A = 25^{\circ}C$ (Note 1b)	1.3		_
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	37	54	mJ
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to	+150	°C

Thermal Characteristics

R_{\thetaJC}	Thermal Resistance, Junction to Case, Single Operation for Q1	(Note 1)	3.5	°C/W
R_{\thetaJC}	Thermal Resistance, Junction to Case, Single Operation for Q2	(Note 1)	3.9	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD3510H	FDD3510H	TO-252-4L	13"	16mm	2500 units

	FDD3510H
	& P-Channe
	PowerTre
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	SFFT

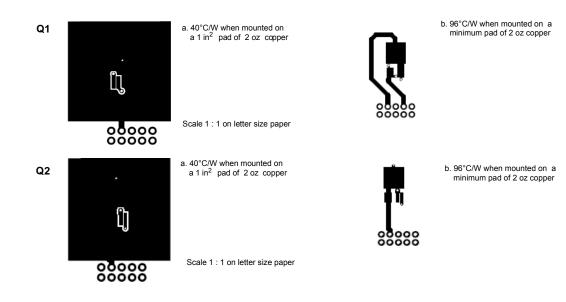
Symbol	Parameter	Test Conditions	Туре	Min	Тур	Мах	Units
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I_{D} =250µA, V_{GS} = 0V I_{D} = -250µA, V_{GS} = 0V	Q1 Q2	80 -80			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250µA, referenced to 25°C I_D = -250µA, referenced to 25°C	Q1 Q2		84 -67	mV	/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 64V, V_{GS} = 0V$ $V_{DS} = -64V, V_{GS} = 0V$	Q1 Q2			1 -1	μA
GSS	Gate to Source Leakage Current	V_{GS} = ±20V, V_{DS} = 0V	Q1 Q2			±100 ±100	nA nA
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$ $V_{GS} = V_{DS}, I_D = -250 \mu A$	Q1 Q2	2.0 -1.0	2.6 -1.6	4.0 -3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250µA, referenced to 25°C I_D = -250µA, referenced to 25°C	Q1 Q2		-6.7 4.6	mV/	°C
r _{DS(on)} Static Drain to Sc	Static Drain to Source On Resistance	$V_{GS} = 10V, I_D = 4.3A$ $V_{GS} = 6.0V, I_D = 4.1A$ $V_{GS} = 10V, I_D = 4.3A, T_J = 125^{\circ}C$	Q1		64 70 121	80 88 152	mΩ
	Static Drain to Source On Resistance	V_{GS} = -10V, I _D = -2.8A V_{GS} = -4.5V, I _D = -2.6A V_{GS} = -10V, I _D = -2.8A, T _J = 125°C	Q2		153 184 259	190 224 322	1115.2
9 _{FS}	Forward Transconductance	$V_{DD} = 10V, I_D = 4.3A$ $V_{DD} = -5V, I_D = -2.8A$	Q1 Q2		15 6.8		S
Dynamic	Characteristics						
C _{iss}	Input Capacitance	Q1 V _{DS} = 40V, V _{GS} = 0V, f = 1MHZ	Q1 Q2		600 660	800 880	pF
C _{oss}	Output Capacitance	Q2	Q1 Q2		56 50	75 70	pF
C _{rss}	Reverse Transfer Capacitance	V _{DS} = -40V, V _{GS} = 0V, f = 1MHZ	Q1 Q2		27 25	41 40	pF
۲ _g	Gate Resistance	f = 1MHz	Q1 Q2		1.7 7.2		Ω
Switching	Characteristics						
d(on)	Turn-On Delay Time	Q1	Q1 Q2		7 6	13 11	ns
tr	Rise Time	$^{}$ V _{DD} = 40V, I _D = 4.3A, V _{GS} = 10V, R _{GEN} = 6Ω	Q1 Q2		2 3	10 10	ns
			01		16	20	

۰۵(on)	rum on beidy nine	Q1	Q2	6	11	110
t _r	Rise Time	V_{DD} = 40V, I _D = 4.3A, V_{GS} = 10V, R _{GEN} = 6 Ω	Q1 Q2	2 3	10 10	ns
t _{d(off)}	Turn-Off Delay Time	Q2 V _{DD} = -40V, I _D = -2.8A,	Q1 Q2	16 25	29 40	ns
t _f	Fall Time	$V_{GS} = -10V, R_{GEN} = 6\Omega$	Q1 Q2	2 5	10 10	ns
Q _{g(TOT)}	Total Gate Charge	Q1	Q1 Q2	13 14	18 20	nC
Q _{gs}	Gate to Source Charge	V _{GS} = 10V, V _{DD} = 40V, I _D = 4.3A Q2	Q1 Q2	2.3 1.9		nC
Q _{gd}	Gate to Drain "Miller" Charge	$V_{GS} = -10V, V_{DD} = -40V, I_D = -2.8A$	Q1 Q2	3.2 2.9		nC

Electric	Electrical Characteristics T _J = 25°C unless otherwise noted							
Symbol	Parameter	Test Conditions	5	Туре	Min	Тур	Max	Units
Drain-Sou	Irce Diode Characteristics							
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 2.6A$ $V_{GS} = 0V, I_S = -2.6A$	(Note 2) (Note 2)	Q1 Q2		0.8 -0.8	1.2 -1.2	V
t _{rr}	Reverse Recovery Time	Q1 I _F = 4.3A, di/dt = 100A/s		Q1 Q2		29 30	46 48	ns
Q _{rr}	Reverse Recovery Charge	Q2 I _F = -2.8A, di/dt = 100A/s		Q1 Q2		28 30	45 48	nC

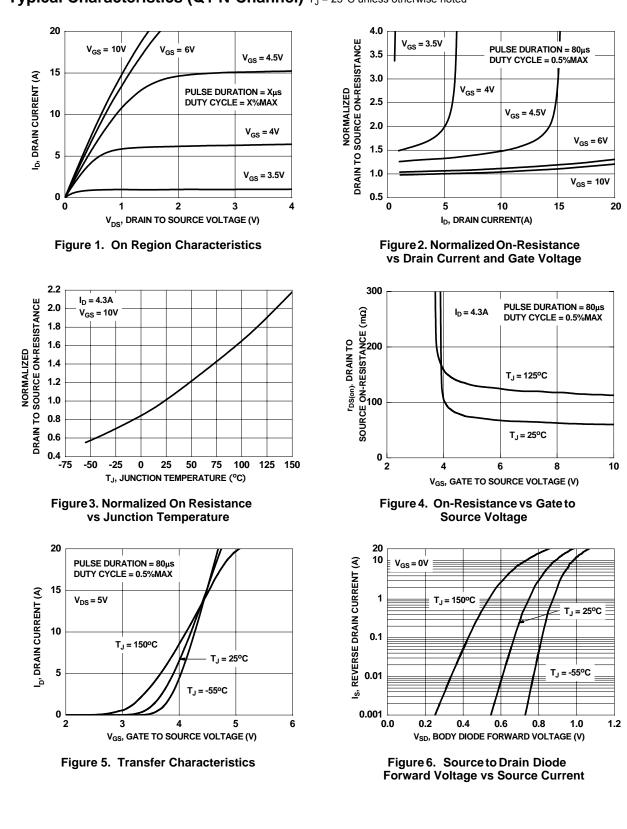
Notes:

1. $R_{\theta JA}$ is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.

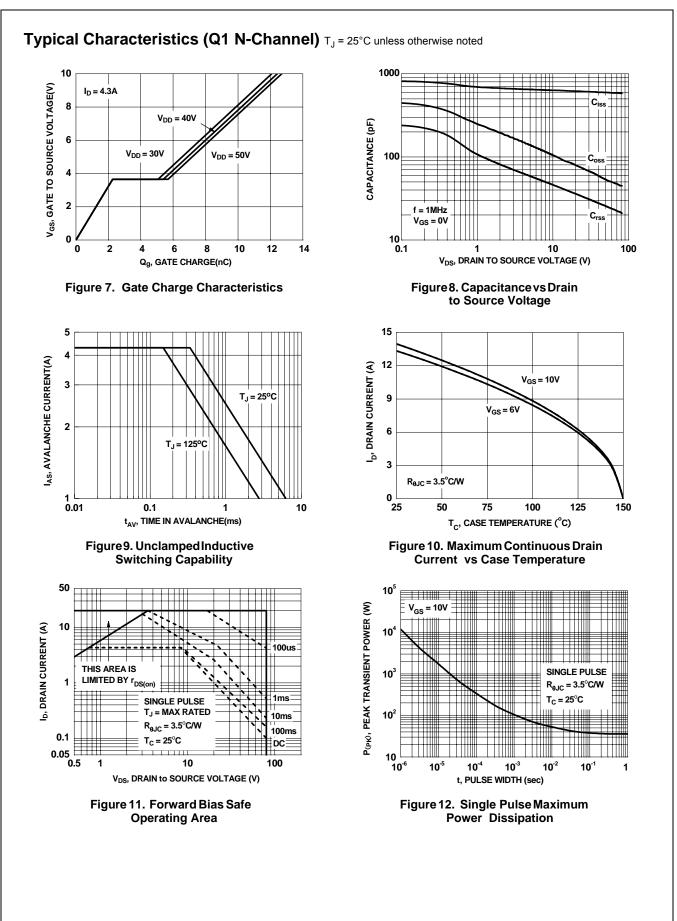


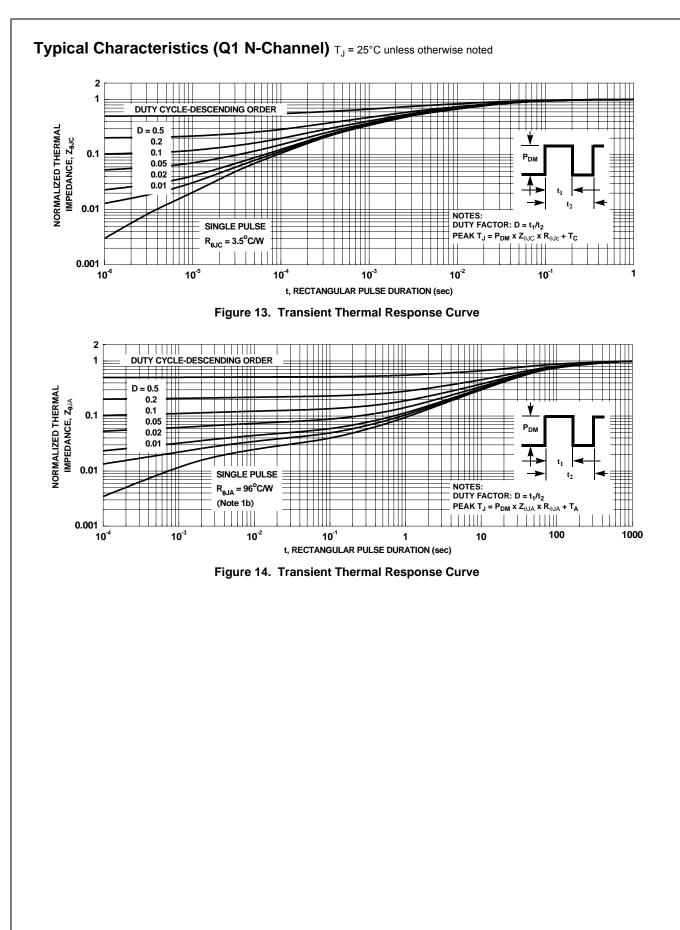
2. Pulse Test: Pulse Width < 300 μs , Duty cycle < 2.0%.

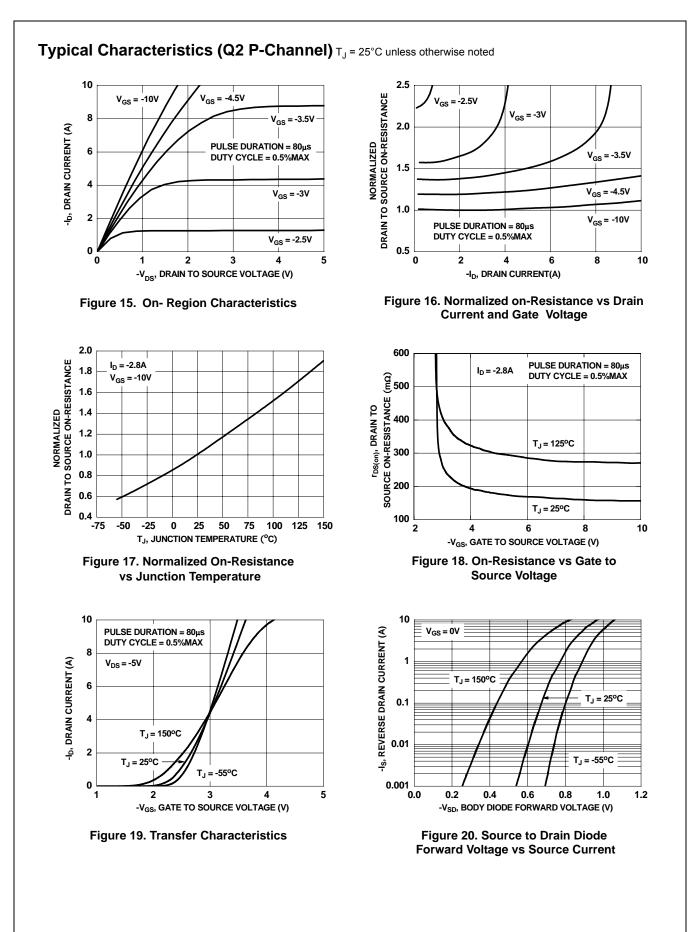
3. Starting T_J = 25°C, N-ch: L = 3mH, I_{AS} = 5A, V_{DD} = 80V, V_{GS} = 10V; P-ch: L = 3mH, I_{AS} = -6A, V_{DD} = -80V, V_{GS} = -10V.



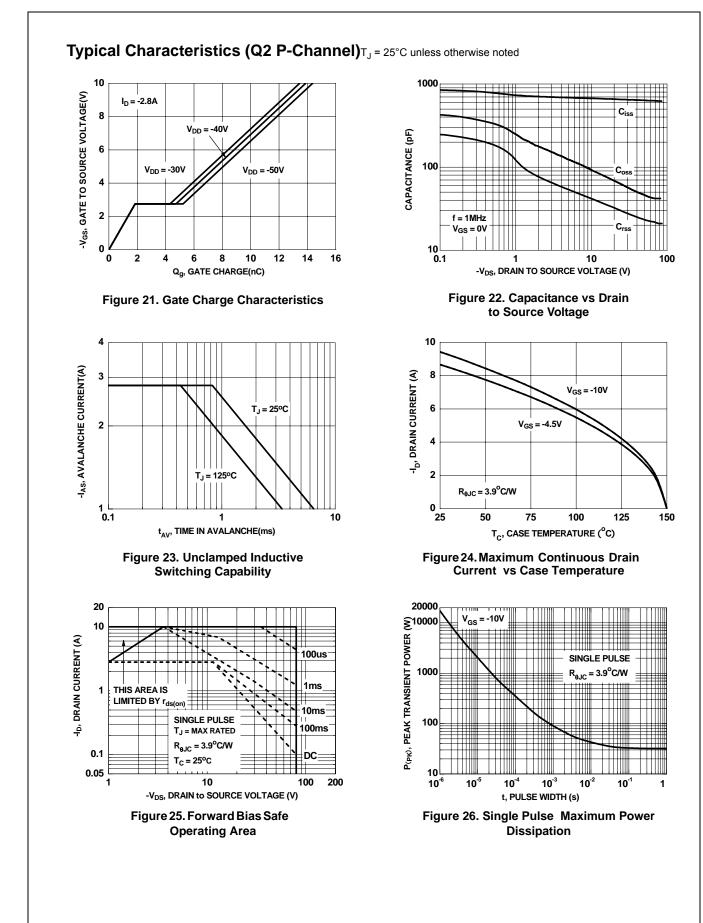
Typical Characteristics (Q1 N-Channel) T_J = 25°C unless otherwise noted



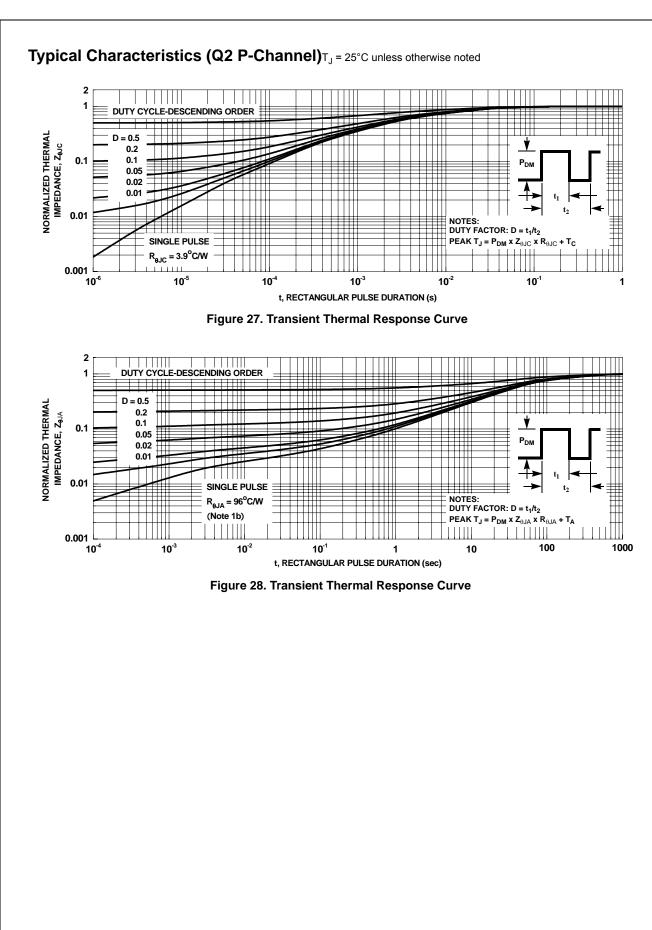


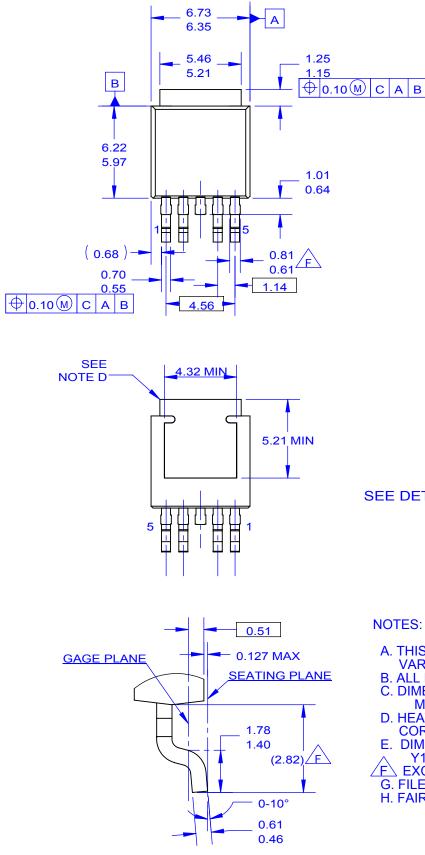




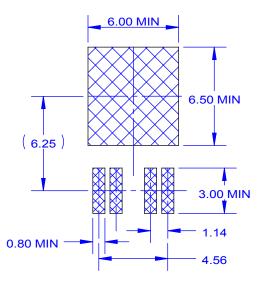


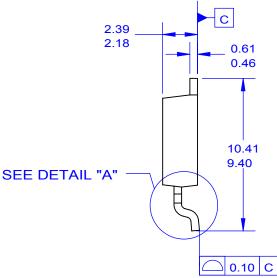






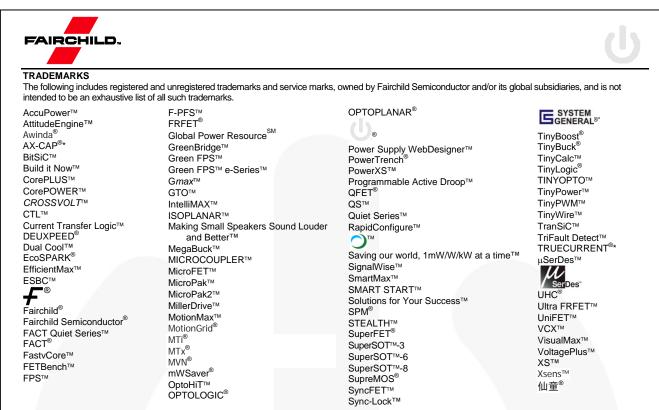
DETAIL A SCALE 2:1





NOTES: UNLESS OTHERWISE SPECIFED

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